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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
Ende SHAN, et al. : EXAMINER: TOLEDO, F.
SERIAL NO.: 09/688,817 : GROUP ART UNIT: 2823
FILED: OCTOBER 17, 2000 :
FOR: LOW TEMPERATURE :
METALLIZATION PROCESS :

RESPONSE UNDER 37 CFR 1.116-
EXPEDITED PROCEDURE EXAMINING
GROUP 2823

AMENDMENT AND REQUEST FOR RECONSIDERATION UNDER 37 C.F.R. 1.116

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

SIR:

In response to the Official Action of November 1, 2002, reconsideration of the above-identified application is respectfully requested in view of the following amendment and remarks.

IN THE CLAIMS

Please cancel claim 21 without prejudice to its further prosecution.

RECONSIDERATION FOR RECONSIDERATION

Upon entry of this amendment Claims 1-20 and 22-24 will now be active in this application. Entry of applicants' amendment at this stage of prosecution is respectfully requested as cancellation of this claim will reduce the issues before the examiner.

The present invention is directed to a method of forming a layer of metal on a substrate.